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(54) Title: PROCESS FOR PLATING PLASTICS USING A CATALYTIC FILLER

(57) Abstract: The present invention relates to an improved process for plating plastics using a catalytic filler. More specifically, the present invention relates to electroless plating. According to the present invention objects are created from a material obtained by compounding a granular plastic with a catalyst suitable for an electroless plating reaction. In a subsequent step, removal of the plastic from the surface of step exposes the catalyst. After this the exposed catalyst is activated. Finally the object is plated in an electroless metal bath.

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